## **ACKNOWLEDGEMENT RECEIPT**

Electronic Version 1.1
Stylesheet Version v1.1.1

Title of Invention

EFS ID:

## HIGH PRESSURE PROCESSING CHAMBER FOR A SEMICONDUCTOR WAFER

Submision Type: Information Disclosure

Statement

Application Number:

10/680783

107799

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Attorney Docket Number:

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File Listing:

Doc. Name	File Name	Size (Bytes)	Date
		, .	Produced
			(yyyymmdd)
us-ids	SSI04001-usidst.xml	1370	2006-07-12
us-ids	us-ids.dtd	7763	2006-07-12
us-ids	us-ids.xsl	12026	2006-07-12
package-data	SSI04001-pkda.xml	1706	2006-07-12
package-data	package-data.dtd	27025	2006-07-12
package-data	us-package-data.xsl	19263	2006-07-12
	Total files size	69153	

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